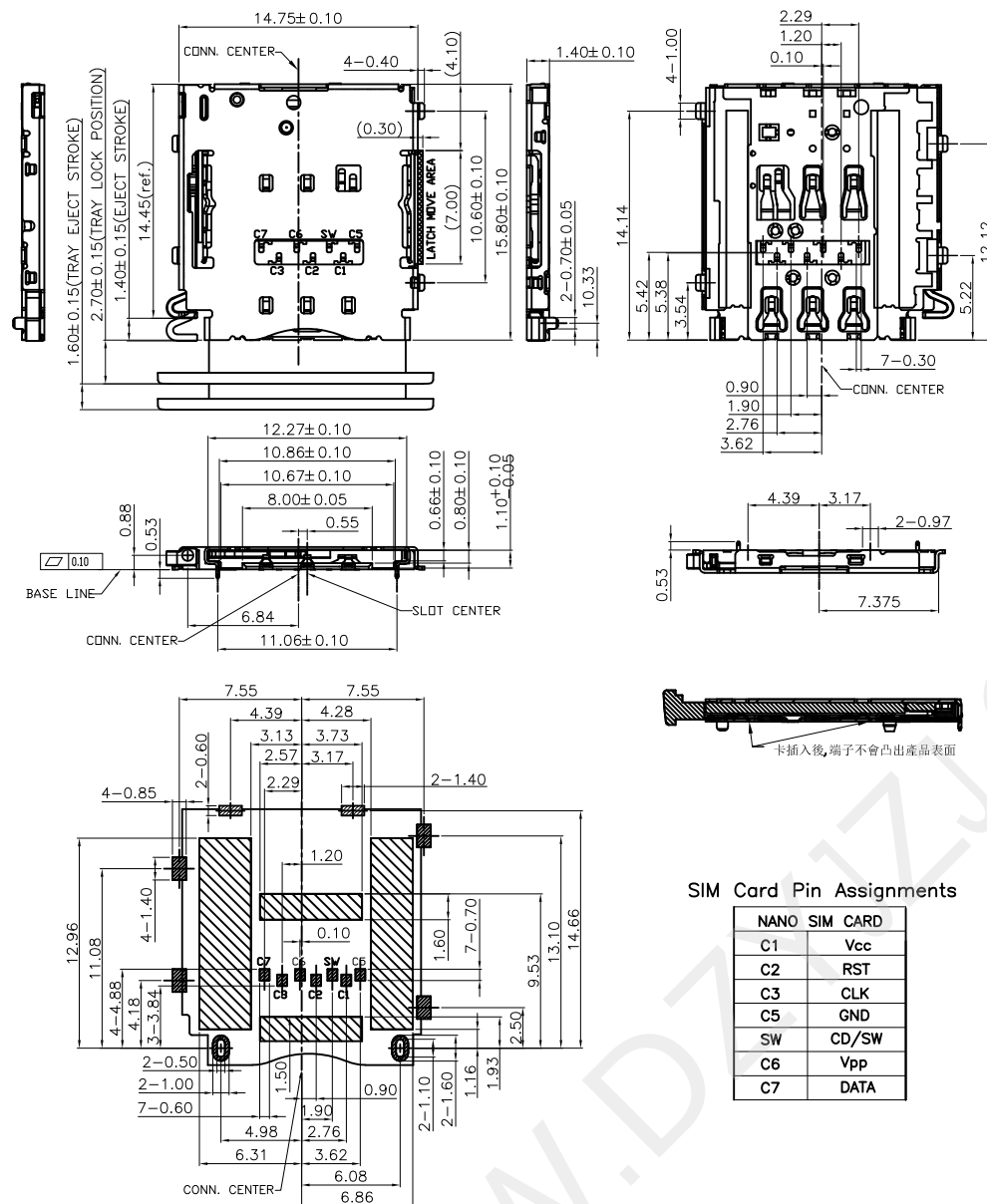




COMPOSITION OF DETECTION

CARD DETECT(SW)

C5 ○ — ○ — ○ — ○ SW

CARD DETECTION/SWITCH

CARD INSTALLATION: ON

NON CARD:OFF

NOTE:

1. MATERIAL:

1.1 HOUSING:

HIGH TEMPERATURE THERMOPLASTIC,(LCP S475)

COLOR:BLACK , UL 94V-0.

1.2 CONTACT: PHOSPHOR BRONZE , C5210R-SH, T=0.08±0.01mm.

1.3 COVER: SUS304 , T=0.20±0.02mm.

2. PLATING:

2.1 CONTACT TERMINAL:

CONTACT AREA: GOLD 1u" Min.

SOLDER AREA : GOLD 1u" Min.

UNDERPLATING : Ni OVERALL 50u" Min.

2.2 COVER:

UNDERPLATING : Ni OVERALL 30u" Min.

3. HalogenFree+ RoHS2

4. MECHANICAL CHARACTERISTIC:

4.1 TRAY INSERTION FORCE: 40N Max.

4.2 TRAY EXTRACTION FORCE: 1N~8N.

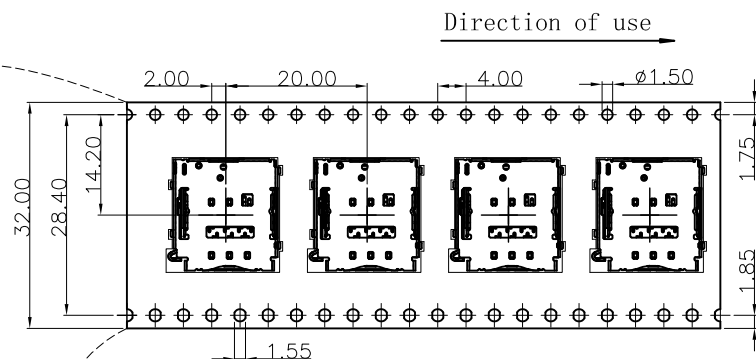
4.3 TRAY EJECTOR PIN FORCE: 15N Max.

5. SYMBOL IS CPK DETECTION DIM.



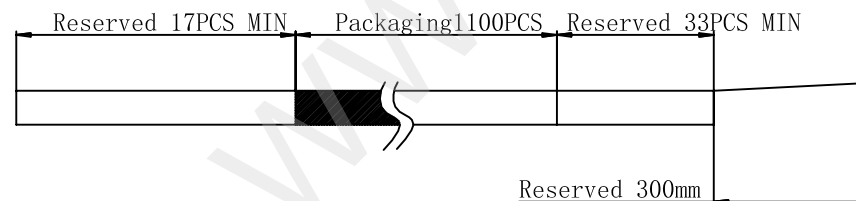
深圳市华宇创精密电子有限公司

TOLERANCE:		DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME:	
X.X ±0.30				NANO SIM 1.4H 卡托式 无柱	
X.XX ±0.25		CHECKED BY: 马跃	DATE : 2014-02-23	PART NO.	HYC392-SIM07-140
X.XXX ±0.15				MOLD NO.	
X.* ±2*	X.X* ±0.5*	APPROVED BY: 邱敏	DATE : 2014-02-23	DRAW NO:	HYC-2607181203
SCALE:1:1	SIZE: A4			SHEET NO.	1 OF 1

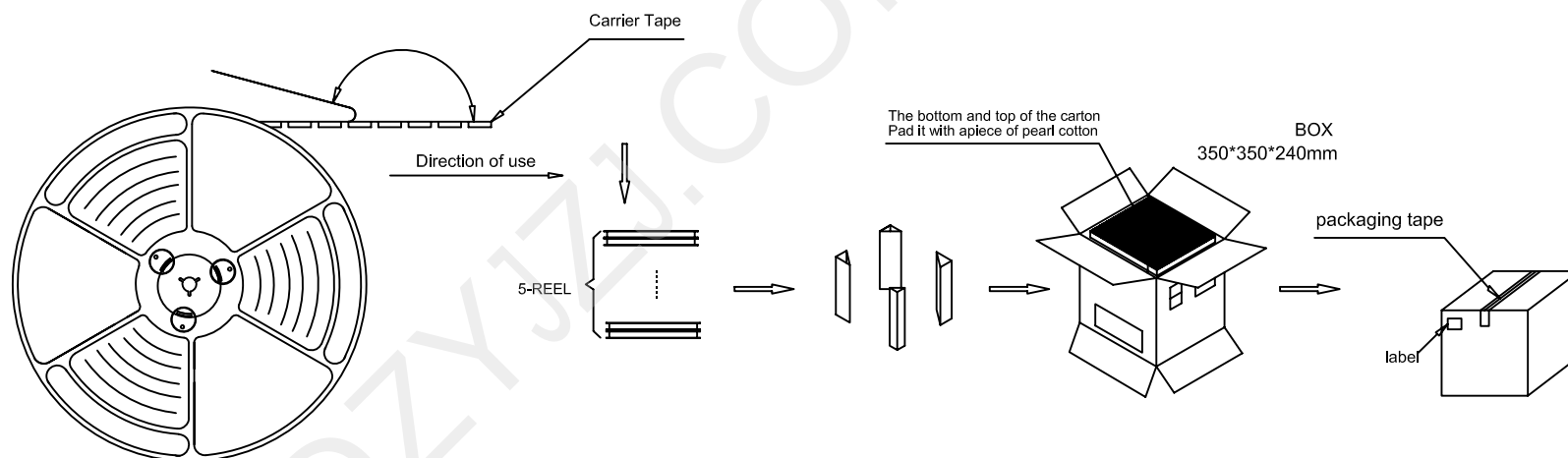


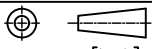
NOTES:

- 1、Packing quantity per plate: 1100PCS/Plate
- 2、Loading and packing method



- 3、Total packaging: 5500PCS/Box



 深圳市华宇创精密电子有限公司			
TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X.' ±2" X.X' ±0.5"	DRAWN BY :	DATE :	PART NAME:
	陈一鸣	2014-02-23	包装图
 UNIT: mm [inch] SCALE:1:1 SIZE: A4	CHECKED BY:	DATE :	PART NO.
	马跃	2014-02-23	MOLD NO.
	APPROVED BY:	DATE :	DRAW NO:
	邱敏	2014-02-23	SHEET NO.
		1 OF 1	